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**Field device integration (FDI) –
Part 103-1: Profiles – PROFIBUS**

**Intégration des appareils de terrain (FDI) –
Partie 103-1: Profils – PROFIBUS**

IEC 62769-103-1:2015

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CONTENTS

FOREWORD.....	4
INTRODUCTION.....	6
1 Scope.....	7
2 Normative references	7
3 Terms, definitions, abbreviated terms and acronyms	8
3.1 Terms and definitions.....	8
3.2 Abbreviated terms and acronyms	8
4 Conventions	8
4.1 EDDL syntax.....	8
4.2 XML syntax.....	8
4.3 Capitalizations	8
5 Profile for PROFIBUS	9
5.1 General.....	9
5.2 Catalog profile	9
5.2.1 Protocol support file.....	9
5.2.2 CommunicationProfile definition.....	9
5.2.3 Profile device.....	10
5.2.4 Protocol version information	10
5.3 Associating a Package with a device.....	11
5.3.1 Device type identification mapping.....	11
5.3.2 Device type revision mapping	12
5.4 Information Model mapping.....	13
5.4.1 ProtocolType definition	13
5.4.2 DeviceType mapping	14
5.4.3 FunctionalGroup identification definition	14
5.5 Topology elements.....	15
5.5.1 ConnectionPoint definition	15
5.5.2 Communication Device definition	17
5.5.3 Communication service provider definition	18
5.5.4 Network definition.....	18
5.6 Methods.....	19
5.6.1 Methods for FDI Communication Servers.....	19
5.6.2 Methods for Gateways	21
Annex A (normative) Topology Scan result schema	28
A.1 General.....	28
A.2 Network	28
A.3 ProfibusNetworkT	28
A.4 ProfibusConnectionPointT.....	28
A.5 ProfibusIdentificationT	29
A.6 ProfibusAddressT	30
Annex B (normative) Transfer service parameters.....	31
B.1 General.....	31
B.2 sendData	31
B.3 xsreceiveData	31
B.4 xsTransferSendDataT	31

B.5	TransferResultDataT.....	32
B.6	OperationT.....	32
	Bibliography.....	33
	Figure 1 – Version mapping problem.....	12
	Table 1 – ProtocolSupportFile for FDI Device Packages	9
	Table 2 – ProtocolSupportFile for FDI Communication Packages	9
	Table 3 – PROFIBUS CommunicationProfile definition schema	10
	Table 4 – Catalog values for profile devices.....	10
	Table 5 – Version mapping examples.....	11
	Table 6 – Device identification information mapping.....	12
	Table 7 – Protocol type Profibus_DP	13
	Table 8 – Protocol type Profibus_PA.....	14
	Table 9 – DeviceType property mapping	14
	Table 10 – PROFIBUS Device Types identification attributes.....	14
	Table 11 – ConnectionPoint type for Profibus_DP.....	15
	Table 12 – ConnectionPoint type for Profibus_PA.....	16
	Table 13 – Method Connect arguments.....	19
	Table 14 – Method Disconnect arguments.....	19
	Table 15 – Method Transfer arguments.....	20
	Table 16 – Method SetAddress arguments.....	21
	Table 17 – Connect service arguments	22
	Table 18 – Method Transfer arguments.....	25
	Table 19 – Method SetAddress arguments.....	26
	Table A.1 – Elements of ProfibusNetworkT	28
	Table A.2 – Attributes of ProfibusConnectionPointT	29
	Table A.3 – Elements of ProfibusConnectionPointT	29
	Table A.4 – Attributes of ProfibusIdentificationT.....	30
	Table B.1 – Attributes of TransferSendDataT	32
	Table B.2 – Attributes of TransferResultDataT	32

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FIELD DEVICE INTEGRATION (FDI) –

Part 103-1: Profiles – PROFIBUS

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The text of this standard is based on the following documents:

CDV	Report on voting
65E/354/CDV	65E/417/RVC

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 62769 series, published under the general title *Field Device Integration (FDI)*, can be found on the IEC website.

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WITHDRAWN

INTRODUCTION

The International Electrotechnical Commission (IEC) draws attention to the fact that it is claimed that compliance with this document may involve the use of patents concerning

- a) method for the supplying and installation of device-specific functionalities, see Patent Family DE10357276;
- b) method and device for accessing a functional module of automation system, see Patent Family EP2182418;
- c) methods and apparatus to reduce memory requirements for process control system software applications, see Patent Family US2013232186;
- d) extensible device object model, see Patent Family US12/893,680.

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FIELD DEVICE INTEGRATION (FDI) – Part 103-1: Profiles – PROFIBUS

1 Scope

This part of IEC 62769 specifies an FDI profile of IEC 62769 for IEC 61784-1_CP 3/1 (PROFIBUS DP)¹ and IEC 61784-1_CP3/2 (PROFIBUS PA).

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 61784-1, *Industrial communication networks – Profiles – Part 1: Fieldbus profiles*

IEC 61804 (all parts), *Function blocks (FB) for process control and Electronic Device Description Language (EDDL)*

IEC 62541-100:2015, *OPC unified architecture – Part 100: Device Interface*

IEC 62769-2, *Field Device Integration (FDI) – Part 2: FDI Client*

NOTE 1 IEC 62769-2 is technically identical to FDI-2022.

IEC 62769-4, *Field Device Integration (FDI) – Part 4: FDI Packages*

NOTE 2 IEC 62769-4 is technically identical to FDI-2024.

IEC 62769-5, *Field Device Integration (FDI) – Part 5: FDI Information Model*

NOTE 3 IEC 62769-5 is technically identical to FDI-2025.

IEC 62769-7, *Field Device Integration (FDI) – Part 7: FDI Communication Devices*

NOTE 4 IEC 62769-7 is technically identical to FDI-2027.

PI Order No.: 2.122:2008, *Specification for PROFIBUS – Device Description and Device Integration – Volume 1: GSD, V5.1, July 2008: GSD*; available at <www.PROFIBUS.com>

¹ PROFIBUS is the trade name of the non-profit consortium PROFIBUS & PROFINET International. This information is given for the convenience of users of this technical report and does not constitute an endorsement by IEC of the trademark holder or any of its products. Compliance does not require use of the trade name. Use of the trade name requires permission of the trade name holder.

3 Terms, definitions, abbreviated terms and acronyms

3.1 Terms and definitions

For the purposes of this document, the terms and definitions given in IEC 61784-1, IEC 61804, IEC 62541-100, IEC 62769-4, IEC 62769-5, IEC 62769-7 and PI Order No.: 2.122:2008 apply.

3.2 Abbreviated terms and acronyms

For the purposes of this document, the following abbreviations apply:

EDD	Electronic Device Description
EDDL	Electronic Device Description Language (see IEC 61804)
GSD	General station description (see PI Order No.: 2.122:2008)
I&M	Identification and maintenance function
UIP	User Interface Plug-in
UUID	Universally unique identifier (see ISO/IEC 11578)
XML	Extensible markup language (see REC-xml-20081126)

4 Conventions

4.1 EDDL syntax

This part of IEC 62769 specifies content for the EDD component that is part of FDI Communication Packages. The specification content using EDDL syntax uses the font Courier New. The EDDL syntax is used for method signature, variable, data structure and component declarations.

4.2 XML syntax

XML syntax examples use the font Courier New. The XML syntax is used to describe XML document schema.

EXAMPLE: `<xs:simpleType name="ExampleType">`

4.3 Capitalizations

The IEC 62769 series use capitalized terms to emphasize that these terms have an FDI specific meaning.

Some of these terms use an acronym as a prefix for example

- FDI Client, or
- FDI Server.

Some of these terms are compound terms such as:

- Communication Servers, or
- Profile Package.

Parameter names or attributes are concatenated to a single term, where the original terms start in this term with a capital letter such as:

- ProtocolSupportFile or
- ProtocolType.

Parameter names or attributes can also be constructed by using an underscore character to concatenate two or more terms such as:

- PROFILE_ID or
- Profibus_PA_Network

5 Profile for PROFIBUS

5.1 General

This profile document to the FDI specification in IEC 62769 specifies the protocol specifics needed for FDI Packages describing Communication Servers, Gateways and Devices.

For Communication Servers this document defines also protocol specifics as these need to be considered in the Communication Servers hosted Information Model.

5.2 Catalog profile

5.2.1 Protocol support file

5.2.1.1 FDI Device Package

Protocol specific attachments are mentioned in the Package Catalog as defined in IEC 62769-5. A communication feature list (GSD) file according to PI Order No.: 2.122:2008 is a mandatory attachment for FDI Device Packages representing PROFIBUS DP and PROFIBUS PA devices. Table 1 specifies the parameters of the ProtocolSupportFile in the FDI Device Package.

Table 1 – ProtocolSupportFile for FDI Device Packages

Parameter	Description
Content Type	text/plain
Root Namespace	empty
Source Relationship	http://fdi-cooperation.com/2010/relationship/attachment-protocol
Filename	According to PI Order No.: 2.122:2008

5.2.1.2 FDI Communication Packages

A GSD file as specified in PI Order No.: 2.122:2008 is an optional attachment for FDI Communication Packages representing PROFIBUS DP and PROFIBUS PA devices. Table 2 specifies the parameters of ProtocolSupportFile for FDI Communication Packages.

Table 2 – ProtocolSupportFile for FDI Communication Packages

Parameter	Description
Content Type:	text/plain
Root Namespace:	empty
Source Relationship:	http://fdi-cooperation.com/2010/relationship/attachment-protocol
Filename:	According to PI Order No.: 2.122:2008

5.2.2 CommunicationProfile definition

IEC 62769-4 defines a CommunicationProfileT enumeration type for the Catalog XML schema. Table 3 defines the PROFIBUS specific values for this enumeration.

Table 3 – PROFIBUS CommunicationProfile definition schema

Profile Identifier	Protocol
"profibus_dp"	PROFIBUS DP/V0; PROFIBUS DP/V1; PROFIBUS DP/V2
"profibus_pa"	PROFIBUS PA

5.2.3 Profile device

A Profile Package shall provide the catalog values for profile devices, enabling the FDI Server to leverage a generic device description, if a specific one is not available. The definitions in Table 4 focus on catalog content that is vendor independent.

Table 4 – Catalog values for profile devices

Element	Attribute	Content
PackageType	-	Profile
CommunicationProfile	-	Empty
DeviceModel	-	<p>The allowed profile identifier values (PROFILE_ID) are provided by PROFIBUS & PROFINET International (PI). PI provides and maintains an XML file (Profile_ID_Table) containing the assignment of PROFILE_ID to profiles.</p> <p>It is available at <http://www.profibus.com/IM/Profile_ID_Table.xml></p> <p>The file can be downloaded by any engineering or service tool whenever it is connected to the Internet.</p> <p>NOTE More information is provided in PI Order No.: 3.502 (I&M Profile) and related profile definitions are referred therein.</p> <p>The string format shall be hexadecimal starting with 0x, e.g. '0x3D00'.</p>

5.2.4 Protocol version information

IEC 62769-4 defines an element type named InterfaceT for the Catalog XML schema. The element type InterfaceT contains an element named Version which is supposed to provide version information about the applied communication protocol profile. The value has to follow the IEC 62769-4 defined version information schema defined in the element type VersionT. Table 5 describes how to apply the currently known protocol versions defined by the non-profit consortium PROFIBUS & PROFINET International. The general rule is to apply the value "0" for parts of the version information according to IEC 62769-4 that are not used in currently known protocol versions.

Table 5 – Version mapping examples²

Protocol / Version	InterfaceT Version value
PROFIBUS DP/V0	0.0.0 ^a
PROFIBUS DP/V1	1.0.0 ^a
PROFIBUS DP/V2	2.0.0 ^a
PROFIBUS PA 3.02	3.2.0 ^b
^a The protocols PROFIBUS DP/V0, PROFIBUS DP/V1 and PROFIBUS DP/V2 contain a single number. This number is considered to be the major version. The minor and built numbers are set to "0".	
^b The currently known PROFIBUS PA profile number is considered to provide major and minor version information. Leading zeros are not considered in version value evaluation since only the actual decimal values are relevant.	

5.3 Associating a Package with a device

5.3.1 Device type identification mapping

The purpose of device type identification mapping is to enable FDI host systems to compare the scan result against the topology representation in the Information Model. FDI host systems shall also be enabled to determine the FDI Device Package that fits for a device entry contained in the scan result. This will enable the user of an FDI host system to synchronize the Information Model with the actual installation.

The Communication Server implemented scan service (defined in 5.6.1.7) provides the scan result through an XML document (the schema is defined in Clause A.5).

The Gateway implemented scan service (defined in 5.6.2.7) provides the scan result by means of the Information Model that contains data structures created from EDD content as specified in 5.6.2.7.

Common for both ways of presenting the scan result is that scan results contain device type identification and device instance identification.

FDI host systems comparing the actual network topology configuration against the topology representation in the Information Model shall be enabled to handle the following situations:

- The physical Device instance identified at a specific device address is not logically present in the Information Model (as Instance): Enable the FDI Host system to find the appropriate FDI Device package according to the device catalogue information.
- The physical Device instance identified by the device address is logically present in the Information Model (as Instance): Enable the FDI Host system to compare device type information presented in the scan result (see the identification in Clause A.5) and the device type specific information of the Instance present in the Information Model.

The FDI Device package contains device type identification information that can be compared to the scan result based on the Catalog Schema in IEC 62769-4 defining the XML (simple) element types "DeviceModel" and "Manufacturer". Both types are used in the (complex) element types "Protocol" and "RegDeviceType".

As a result of the FDI Package deployment the FDI Package information is then present in the Information Model as the specified FunctionalGroup Identification containing Ident_Number and Manufacturer_ID (see 5.4.3). The Ident_Number matches with the GSD specified

² The given table can be considered to be an example only since this document cannot foresee how future protocol versions will be defined.

Ident_Number. Manufacturer_ID is specified through the I&M profile defined VendorID and DeviceID (see 5.4.3).

The mapping between different device identification data sources is described in Table 6. Since scan results provided by the Communication Server or Gateway can convey data that is produced by the device (firmware) the device type identification mapping shall be supported by providing corresponding data in the FDI Device Package contained Catalog and Information Model.

Table 6 – Device identification information mapping

FDI Device Package	Information Model	Communication Server provided scan result	Gateway provided scan result
Catalog specified type Manufacturer	FunctionalGroup: Identification Browse Name: Manufacturer_ID	Element (path): ConnectionPoint/Identificati on Attribute: Manufacturer_ID	COLLECTION ConnectionPoint Identification Manufacturer_ID
Catalog specified type DeviceModel	FunctionalGroup: Identification Browse Name: Ident_Number	Element (path): ConnectionPoint/Identificati on Attribute: Ident_Number	COLLECTION ConnectionPoint. Identification. Ident_Number

5.3.2 Device type revision mapping

IEC 62769-4 envisions a concept that allows to determine the compatibility between an FDI Device Package and a Device. IEC 62769-4 specifies a life cycle management process bearing on a single version information provided for the entire device.

NOTE PROFIBUS related specifications, for example PI Order No.: 2.122:2008 (GSD) and PI Order No.: 3.502:2009 (I&M) splits the device type revision into software and hardware related information. The GSD specifies the attributes Hardware_Release and Software_Release. The I&M specifies HARDWARE_REVISION and SOFTWARE_REVISION. Hardware_Release and HARDWARE_REVISION must always match. Software_Release and SOFTWARE_REVISION must always match.

The goal of 5.3.2 is to describe the translation rules between PROFIBUS related specifications, describing their way of providing the version information, and the IEC 62769-4 specified way of containing the version information that can be compared against the version read from the device. The purpose is to determine the compatibility between an FDI Device Package and a Device. Figure 1 depicts the problem.

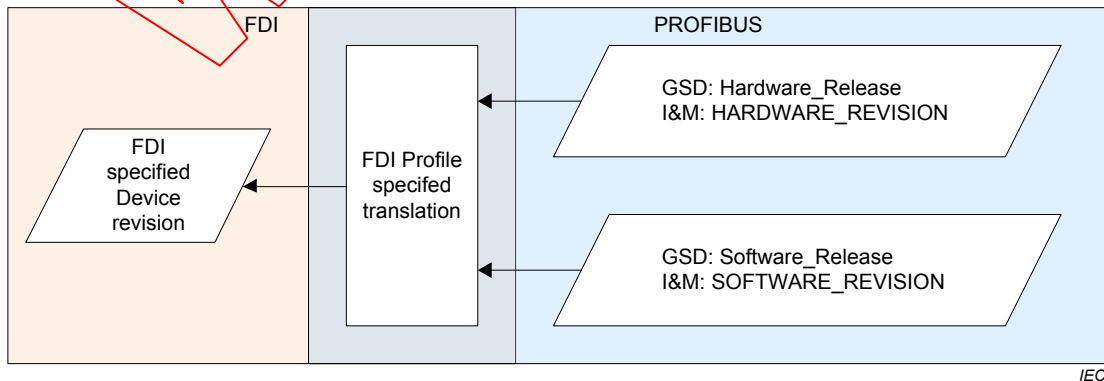


Figure 1 – Version mapping problem

The firmware of a device implements the data exchange interface which shall be described by means of the FDI Device Package content (EDD). A device firmware that implements the PROFIBUS PA profile enables the reading of the values SOFTWARE_REVISION and